Unit in mm

TOSHIBA DIODE SILICON EPITAXIAL PLANAR TYPE

1 S V 3 0 9

UHF SHF TUNING

High Capacitance Ratio : $C_{2V}/C_{25V}=5.7$ (Typ.)

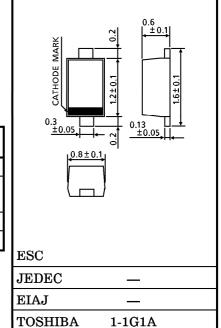
: $r_{\rm S} = 1.2\Omega$ (Typ.) Low Series Resistance

Excellent C-V Characteristics, and Small Tracking Error

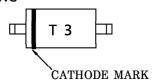
Useful for Small Size Tuner

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Reverse Voltage	$v_{ m R}$	30	V
Peak Reverse Voltage	v_{RM}	$(R_L = 10 k\Omega)$	V
Junction Temperature	T_{j}	125	$^{\circ}\mathrm{C}$
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125	$^{\circ}\mathrm{C}$



MARKING



ELECTRICAL CHARACTERISTICS (Ta = 25°C)

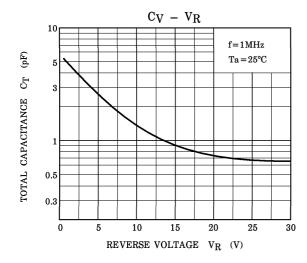
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT		
Reverse Voltage	v_{R}	$I_R = 1 \mu A$	30			V		
Reverse Current	I_{R}	$V_R = 28V$	_		10	nA		
Capacitance	C2V	V_R =2V, f=1MHz	3.31	_	4.55	рF		
Capacitance	$\mathrm{c}_{25\mathrm{V}}$	V_R =25V, f=1MHz	0.61	_	0.77	pF		
Capacitance Ratio	C_{2V}/C_{25V}	_	5.0	_	6.5	_		
Series Resistance	$r_{\rm S}$	$V_R=1V$, $f=470MHz$	1	1.2	2.0	Ω		

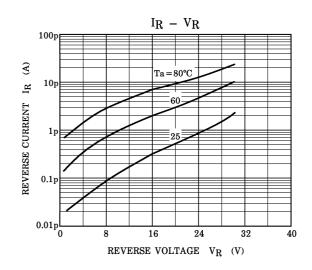
(Note) Unites are compounded in one package and are matched to 6.0%.

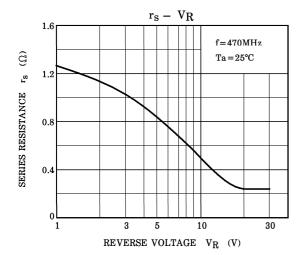
$$\frac{C \text{ (Max.)} - C \text{ (Min.)}}{C \text{ (Min.)}} \leq 0.06$$

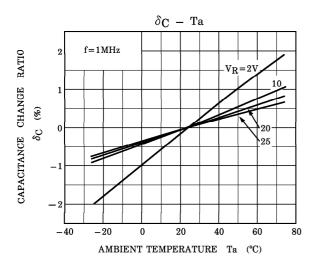
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NOTE :
$$\delta_{\text{C}}$$
 (%) = $\frac{\text{C}\left(\text{Ta}=\text{T}^{\circ}\text{C}\right) - \text{C}\left(\text{Ta}=25^{\circ}\text{C}\right)}{\text{C}\left(\text{Ta}=25^{\circ}\text{C}\right)} \times 100$

SPICE PARAMETER

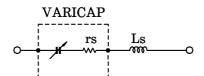
SPICE MODEL : BERKLEY SPICE.2G.6 DIODE MODEL

DATA FORMAT : MODEL FORMAT

SPICE SYMBOL : $I_S(A)$, $R_S(\Omega)$, N(-), CJ0(F), $V_J(V)$, M(-), $B_V(V)$, $I_{BV}(A)$

FREQUENCY RANGE : $f = 0.1 \sim 3 \, \text{GHz}$ REVERSE VOLTAGE RANGE : $V_R = 2 \sim 25 \, \text{V}$

PARAMETER



(Note 1): These parameters from IS to M mean die characteristic.

Actually device has lead inductance so Ls is necessary for simulation.

And please use default value except above parameters.

(Note 2): R_S shows the value at the condition of $V_R = 1 V$ and f = 470 MHz. If another value is needed, please refer to $R_S - V_R$ curve in this data sheets.